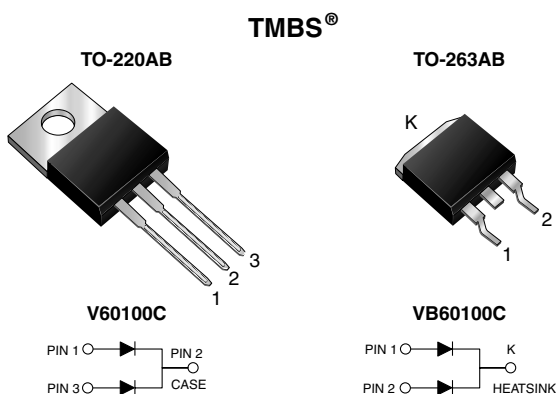




## Dual High-Voltage Trench MOS Barrier Schottky Rectifier

Ultra Low  $V_F = 0.36\text{ V}$  at  $I_F = 5\text{ A}$



### FEATURES

- Trench MOS Schottky technology
- Low forward voltage drop, low power losses
- High efficiency operation
- Low thermal resistance
- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C (for TO-263AB package)
- Solder bath temperature 275 °C maximum, 10 s, per JESD 22-B106 (for TO-220AB)
- Compliant to RoHS directive 2002/95/EC and in accordance to WEEE 2002/96/EC



RoHS  
COMPLIANT

### TYPICAL APPLICATIONS

For use in high frequency converters, switching power supplies, freewheeling diodes, OR-ing diode, dc-to-dc converters and reverse battery protection.

### PRIMARY CHARACTERISTICS

$I_{F(AV)}$	2 x 30 A
$V_{RRM}$	100 V
$I_{FSM}$	320 A
$V_F$ at $I_F = 30\text{ A}$	0.66 V
$T_J$ max.	150 °C

### MECHANICAL DATA

**Case:** TO-220AB and TO-263AB

Molding compound meets UL 94 V-0 flammability rating

Base P/N-E3 - RoHS compliant, commercial grade

**Terminals:** Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test

**Polarity:** As marked

**Mounting Torque:** 10 in-lbs maximum

### MAXIMUM RATINGS ( $T_A = 25\text{ °C}$ unless otherwise noted)

PARAMETER	SYMBOL	V60100C	VB60100C	UNIT
Maximum repetitive peak reverse voltage	$V_{RRM}$	100		V
Maximum average forward rectified current (fig. 1) per device per diode	$I_{F(AV)}$	60	30	A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load per diode	$I_{FSM}$	320		A
Non-repetitive avalanche energy at $T_J = 25\text{ °C}$ , $L = 140\text{ mH}$ per diode	$E_{AS}$	450		mJ
Peak repetitive reverse current at $t_p = 2\text{ }\mu\text{s}$ , 1 kHz, $T_J = 38\text{ °C} \pm 2\text{ °C}$ per diode	$I_{RRM}$	1.0		A
Voltage rate of change (rated $V_R$ )	$dV/dt$	10 000		V/ $\mu\text{s}$
Operating junction and storage temperature range	$T_J, T_{STG}$	- 40 to + 150		°C

# V60100C & VB60100C

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ELECTRICAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Breakdown voltage	I <sub>R</sub> = 1.0 mA	T <sub>A</sub> = 25 °C	V <sub>BR</sub>	100 (minimum)	-	
Instantaneous forward voltage per diode <sup>(1)</sup>	I <sub>F</sub> = 5 A I <sub>F</sub> = 10 A I <sub>F</sub> = 15 A I <sub>F</sub> = 20 A I <sub>F</sub> = 30 A	T <sub>A</sub> = 25 °C	V <sub>F</sub>	0.45 0.52 0.58 0.63 0.73	- - 0.63 - 0.79	V
	I <sub>F</sub> = 5 A I <sub>F</sub> = 10 A I <sub>F</sub> = 15 A I <sub>F</sub> = 20 A I <sub>F</sub> = 30 A	T <sub>A</sub> = 125 °C		0.36 0.45 0.53 0.58 0.66	- - 0.58 - 0.70	
Reverse current at rated V <sub>R</sub> per diode <sup>(2)</sup>	V <sub>R</sub> = 80 V	T <sub>A</sub> = 25 °C T <sub>A</sub> = 125 °C	I <sub>R</sub>	24 13	500 20	μA mA
	V <sub>R</sub> = 100 V	T <sub>A</sub> = 25 °C T <sub>A</sub> = 125 °C		65 30	1000 -	μA mA

**Notes**

(1) Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	V60100C	VB60100C	UNIT
Typical thermal resistance per diode	R <sub>θJC</sub>	2.5	2.5	°C/W

ORDERING INFORMATION					
PACKAGE	PREFERRED P/N	UNIT WEIGHT (g)	PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
TO-220AB	V60100C-E3/4W	1.89	4W	50/tube	Tube
TO-263AB	VB60100C-E3/4W	1.38	4W	50/tube	Tube
TO-263AB	VB60100C-E3/8W	1.38	8W	800/reel	Tape and reel

## RATINGS AND CHARACTERISTICS CURVES

(T<sub>A</sub> = 25 °C unless otherwise noted)

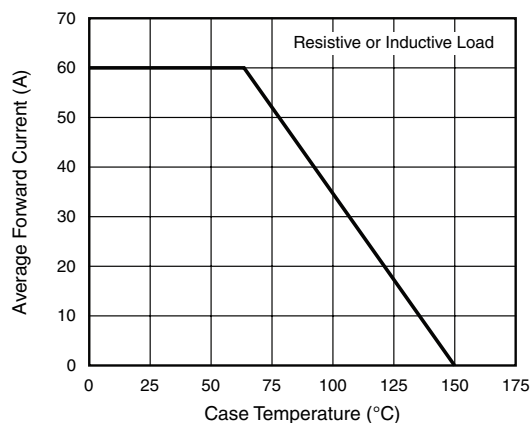


Figure 1. Forward Current Derating Curve

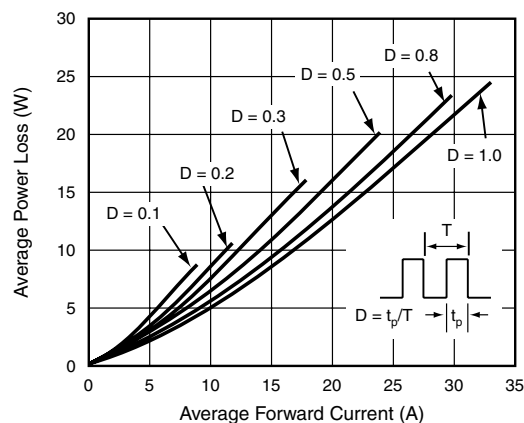


Figure 2. Forward Power Loss Characteristics Per Diode



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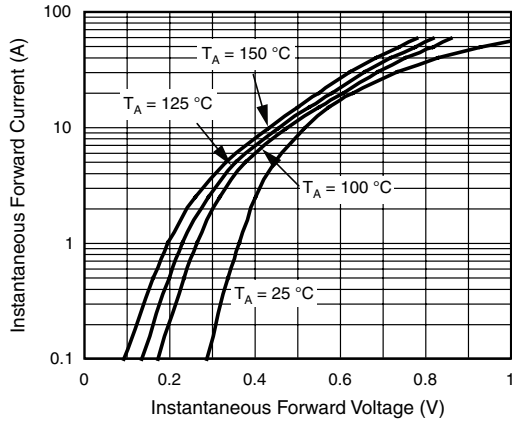


Figure 3. Typical Instantaneous Forward Characteristics Per Diode

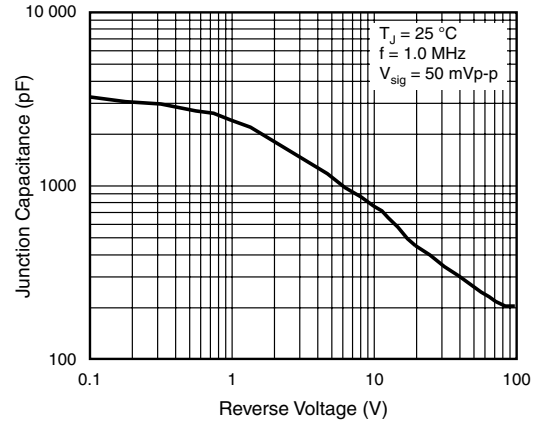


Figure 5. Typical Junction Capacitance Per Diode

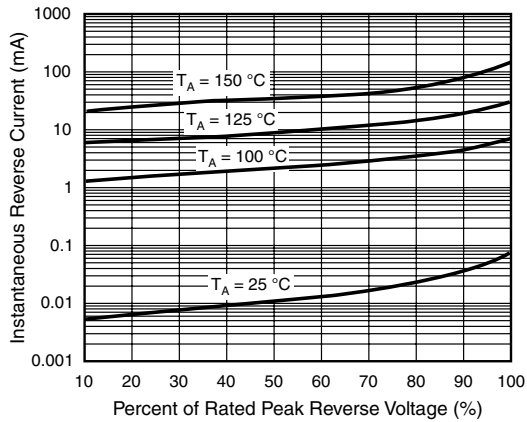


Figure 4. Typical Reverse Characteristics Per Diode

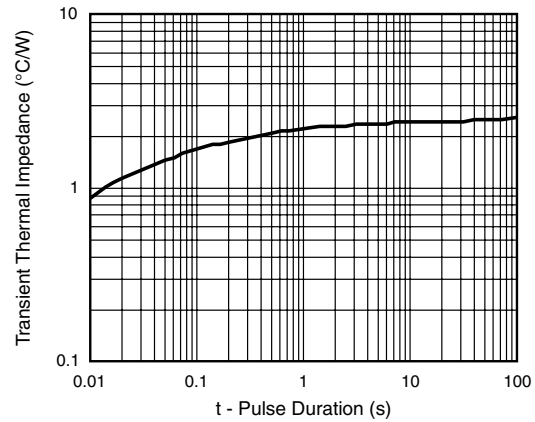


Figure 6. Typical Transient Thermal Impedance Per Diode

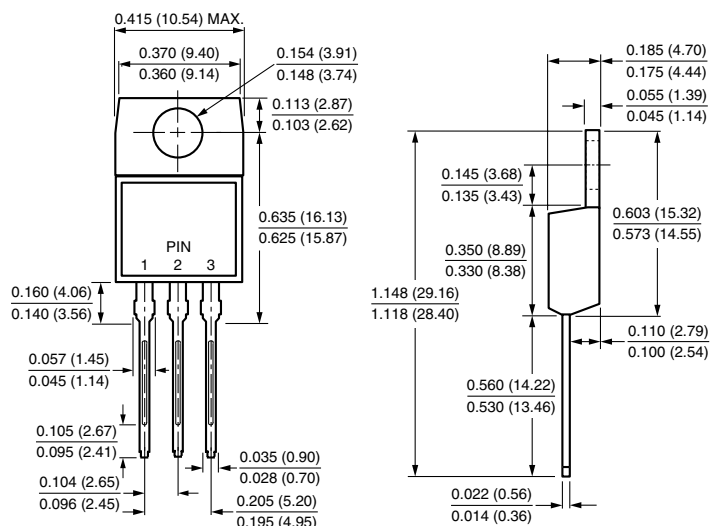
# V60100C & VB60100C

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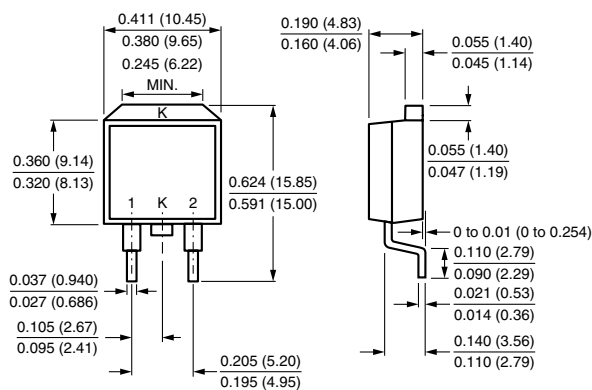


## PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

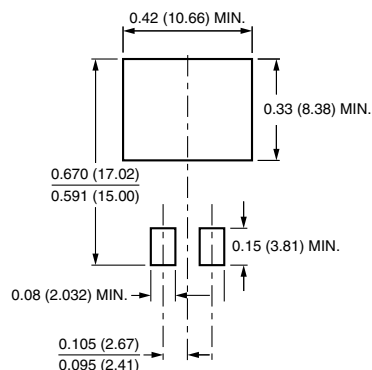
### TO-220AB



### TO-263AB



### Mounting Pad Layout





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